

SN751177, SN751178 Dual Differential Drivers and Receivers

1 Features

- Meet or exceed the requirements of ANSI standards TIA/EIA-422-B and TIA/EIA-485-A and ITU recommendations V.10 and V.11
- Designed for multipoint bus transmission on long bus lines in noise environments
- Driver positive- and negative-current limiting
- Thermal shutdown protection
- Driver 3-state outputs
- Receiver common-mode input voltage range of -12V to 12V
- Receiver input sensitivity: $\pm 200\text{mV}$
- Receiver hysteresis: 50mV typical
- Receiver input impedance: 12 k Ω minimum
- Receiver 3-state outputs (SN751177 only)
- Operate from single 5V supply

2 Applications

- [Motor Drives](#)
- [Factory Automation](#)
- [Building Automation](#)

3 Description

The SN751177 and SN751178 dual differential drivers and receivers are monolithic integrated circuits that are designed for balanced multipoint bus transmission at rates up to 10 Mbits. The devices are designed to improve the performance of full-duplex data communications over long bus lines and meet ANSI Standards TIA/EIA-422-B and TIA/EIA-485-A and ITU Recommendations V.10 and V.11.

The SN751177 and SN751178 driver outputs provide limiting for both positive and negative currents and thermal-shutdown protection from line-fault conditions on the transmission bus line.

The receiver features high input impedance of at least 12k Ω , an input sensitivity of $\pm 200\text{mV}$ over a common-mode input voltage range of -12V to 12V, and typical input hysteresis of 50mV. Fail-safe design makes sure the receiver inputs are open, the receiver outputs are always high.

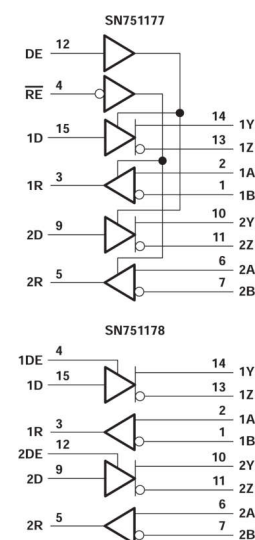
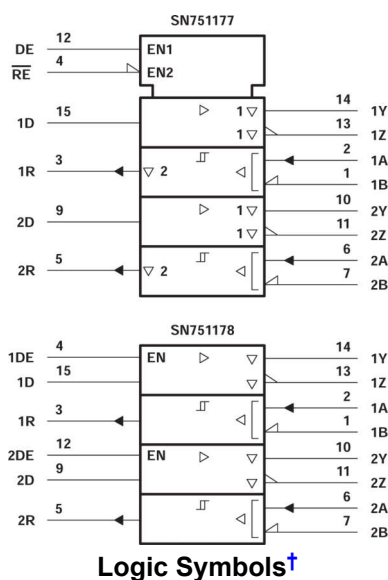
The SN751177 and SN751178 are characterized for operation from -20°C to 85°C.

Package Information

| PART NUMBER | PACKAGE ⁽¹⁾ | PACKAGE SIZE ⁽²⁾ |
|-------------|------------------------|-----------------------------|
| SN751177 | PDIP (N, 16) | 19.3mm × 9.4mm |
| SN751178 | SO (NS, 16) | 10.2mm × 7.8mm |

(1) For more information, see [Section 10](#).

(2) The package size (length × width) is a nominal value and includes pins, where applicable.



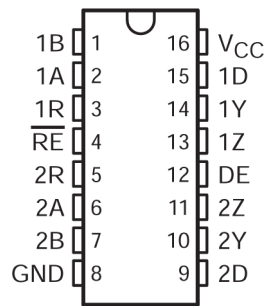
[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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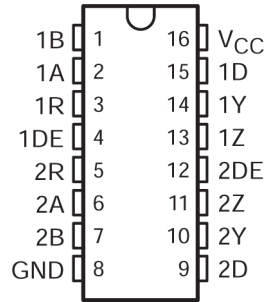
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4 Pin Configuration and Functions



**Figure 4-1. SN751177: N or NS Package
(Top View)**

| NAME | PIN | | TYPE | DESCRIPTION |
|-----------------|------|----|------|--|
| | PDIP | SO | | |
| 1A | 2 | 2 | I | RS422 differential input (non-inverting) to receiver 1 |
| 2A | 6 | 6 | I | RS422 differential input (non-inverting) to receiver 2 |
| 1B | 1 | 1 | I | RS422 differential input (inverting) to receiver 1 |
| 2B | 7 | 7 | I | RS422 differential input (inverting) to receiver 2 |
| 1D | 15 | 15 | I | Logic data input to RS422 driver 1 |
| 2D | 9 | 9 | I | Logic data input to RS422 driver 2 |
| DE | 12 | 12 | I | Driver enable (active high) |
| GND | 8 | 8 | — | Device ground pin |
| 1R | 3 | 3 | O | Logic data output of RS422 receiver 1 |
| 2R | 5 | 5 | O | Logic data output of RS422 receiver 2 |
| RE | 4 | 4 | I | Receiver enable pin (active low) |
| V _{CC} | 16 | 16 | — | Power supply |
| 1Y | 14 | 14 | O | RS-422 differential (non-inverting) driver output 1 |
| 2Y | 10 | 10 | O | RS-422 differential (non-inverting) driver output 2 |
| 1Z | 13 | 13 | O | RS-422 differential (inverting) driver output 1 |
| 2Z | 11 | 11 | O | RS-422 differential (inverting) driver output 2 |



**Figure 4-2. SN751178: N or NS Package
(Top View)**

| NAME | PIN | | TYPE | DESCRIPTION |
|-----------------|------|----|------|--|
| | PDIP | SO | | |
| 1A | 2 | 2 | I | RS422 differential input (non-inverting) to receiver 1 |
| 2A | 6 | 6 | I | RS422 differential input (non-inverting) to receiver 2 |
| 1B | 1 | 1 | I | RS422 differential input (inverting) to receiver 1 |
| 2B | 7 | 7 | I | RS422 differential input (inverting) to receiver 2 |
| 1D | 15 | 15 | I | Logic data input to RS422 driver 1 |
| 2D | 9 | 9 | I | Logic data input to RS422 driver 2 |
| 1DE | 4 | 4 | I | Driver 1 enable (active high) |
| 2DE | 12 | 12 | I | Driver 2 enable (active high) |
| GND | 8 | 8 | — | Device ground |
| 1R | 3 | 3 | O | Logic data output of RS422 receiver 1 |
| 2R | 5 | 5 | O | Logic data output of RS422 receiver 2 |
| V _{CC} | 16 | 16 | — | Power supply |
| 1Y | 14 | 14 | O | RS-422 differential (non-inverting) driver output 1 |
| 2Y | 10 | 10 | O | RS-422 differential (non-inverting) driver output 2 |
| 1Z | 13 | 13 | O | RS-422 differential (non inverting) driver output 1 |
| 2Z | 11 | 11 | O | RS-422 differential (non inverting) driver output 2 |

5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | MIN | MAX | UNIT |
|------------------|---|-----|-----|------|
| V _{CC} | Supply voltage, (see note ⁽²⁾) | | 7 | V |
| V _I | Input voltage, (DE, \overline{RE} , and D inputs) | | 7 | V |
| V _I | Receiver input voltage range, (A or B inputs) | -25 | 25 | V |
| V _{ID} | Receiver differential input voltage range, (see note ⁽³⁾) | -25 | 25 | V |
| V _O | Driver output voltage range | -10 | 15 | V |
| I _{OL} | Receiver low-level output current | | 50 | mA |
| T _{stg} | Storage temperature range | -65 | 150 | °C |
| | Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | | 260 | °C |

- (1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential input voltage, are with respect to the network ground terminal.
- (3) Differential input voltage is measured at the noninverting terminal with respect to the inverting terminal.

5.2 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | N | NS | UNIT |
|-------------------------------|---|---------|---------|------|
| | | 16-PINS | 16-PINS | |
| R _{θJA} | Junction-to-ambient thermal resistance ⁽²⁾ | 60.6 | 88.5 | °C/W |
| R _{θJC(top)} | Junction-to-case (top) thermal resistance | 48.1 | 46.2 | °C/W |
| R _{θJB} | Junction-to-board thermal resistance | 40.6 | 50.7 | °C/W |
| Ψ _{JT} | Junction-to-top characterization parameter | 27.5 | 13.5 | °C/W |
| Ψ _{JB} | Junction-to-board characterization parameter | 40.3 | 50.3 | °C/W |
| R _{θJC(bot)} | Junction-to-case (bottom) thermal resistance | N/A | N/A | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC package thermal metrics](#) application report.
- (2) The package thermal impedance is calculated in accordance with JEDEC 51, except for through-hole packages, which use a trace length of zero.

5.3 Recommended Operating Conditions

| | | MIN | NOM | MAX | UNIT |
|--|------------------------------------|-------------------|-----|------|------|
| Supply voltage, V _{CC} | | 4.75 | 5 | 5.25 | V |
| High-level input voltage, V _{IH} | DE, \overline{RE} , and D inputs | 2 | | | V |
| Low-level input voltage, V _{IL} | | | | 0.8 | V |
| Common-mode output voltage, V _{OC} | Driver | -7 ⁽¹⁾ | | 12 | V |
| High-level output current, I _{OH} | | | | -60 | mA |
| Low-level output current, I _{OL} | | | | 60 | mA |
| Common-mode input voltage, V _{IC} | | | | ±12 | V |
| Differential input voltage, V _{ID} | Receiver | | | ±12 | V |
| High-level output current, I _{OH} | | | | -400 | μA |
| Low-level output current, I _{OL} | | | | 16 | mA |
| Operating free-air temperature, T _A | | | -20 | | 85 |

- (1) The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode output and threshold voltage levels only.

5.4 Driver Sections

5.4.1 Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | | MIN | TYP ⁽¹⁾ | MAX | UNIT |
|------------------|--|------------------------------------|--------------------------------|------------------------------------|-----------------------------------|--------------------|-----------|---------------|
| V_{IK} | Input clamp voltage | $I_I = -18\text{mA}$ | | | | | -1.5 | V |
| V_{OH} | High-level output voltage | $V_{IH} = 2\text{V}$, | $V_{IL} = 0.8\text{V}$, | $I_{OH} = -33\text{mA}$ | | 3.7 | | V |
| V_{OL} | Low-level output voltage | $V_{IH} = 2\text{V}$, | $V_{IL} = 0.8\text{V}$, | $I_{OH} = 33\text{mA}$ | | 1.1 | | V |
| $ V_{OD1} $ | Differential output voltage | $I_O = 0$ | | | 1.5 | | 6 | V |
| $ V_{OD2} $ | Differential output voltage | $R_L = 100\Omega$, | See Figure 6-1 | | 2 or 1/2 V_{OD1} ⁽²⁾ | | | V |
| | | $R_L = 54\Omega$, | See Figure 6-1 | | 1.5 | | 5 | |
| V_{OD3} | Differential output voltage | See Note 4 | | | 1.5 | | 5 | V |
| $\Delta V_{OD} $ | Change in magnitude of differential output voltage (see Note 5) | | | | | | ± 0.2 | V |
| V_{OC} | Common-mode output voltage | $R_L = 54\Omega$ or 100Ω , | | See Figure 6-1 | -1 ⁽³⁾ | | 3 | V |
| $\Delta V_{OC} $ | Change in magnitude of common-mode output voltage (see Note 5) | | | | | | ± 0.2 | V |
| I_O | Output current with power off | $V_{CC} = 0$, | | $V_O = -7\text{V}$ to 12V | | | ± 100 | μA |
| I_{OZ} | High-impedance-state output current | $V_O = -7\text{V}$ to 12V | | | | | ± 100 | μA |
| I_{IH} | High-level input current | $V_{IH} = 2.7\text{V}$ | | | | | 20 | μA |
| I_{IL} | Low-level input current | $V_{IL} = 0.4\text{V}$ | | | | | -100 | μA |
| | | $V_O = -7\text{V}$ | | | | | -250 | |
| I_{OS} | Short-circuit output current (see Note 6) | $V_O = V_{CC}$ | | | | | 250 | mA |
| | | $V_O = 12\text{V}$ | | | | | 250 | |
| I_{CC} | Supply current | No load | Outputs enabled | | | 80 | 110 | mA |
| | | | Outputs disabled | | | 50 | 80 | |

(1) All typical values are at $V_{CC} = 5\text{V}$ and $T_A = 25^\circ\text{C}$.

(2) The minimum V_{OD2} with a 100Ω load is either $1/2 V_{OD1}$ or 2V , whichever is greater.

(3) The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode output and threshold voltage levels only.

(4) See TIA/EIA-485-A [Figure 6-3.5](#), Test Termination Measurement 2

(5) $\Delta|V_{OD}|$ and $\Delta|V_{OC}|$ are the changes in magnitude of V_{OD} and V_{OC} , respectively, that occur when the input is changed from a high level to a low level.

(6) Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

5.4.2 Switching Characteristics

at $V_{CC} = 5\text{V}$, $C_L = 50\text{pF}$, $T_A = 25^\circ\text{C}$

| PARAMETER | | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|-------------|---|---------------------|--------------------------------|-----|-----|-----|------|
| $t_{d(OD)}$ | Differential output delay time | $R_L = 54\Omega$, | See Figure 6-3 | | 20 | 25 | ns |
| $t_{t(OD)}$ | Differential output transition time | | | | 27 | 35 | ns |
| t_{PLH} | Propagation delay time, low- to high-level output | $R_L = 27\Omega$, | See Figure 6-4 | | 20 | 25 | ns |
| t_{PHL} | Propagation delay time, high- to low-level output | | | | 20 | 25 | ns |
| t_{PZH} | Output enable time to high level | $R_L = 110\Omega$, | See Figure 6-5 | | 80 | 120 | ns |
| t_{PZL} | Output enable time to low level | $R_L = 110\Omega$, | See Figure 6-6 | | 40 | 60 | ns |
| t_{PHZ} | Output disable time from high level | $R_L = 110\Omega$, | See Figure 6-5 | | 90 | 120 | ns |
| t_{PLZ} | Output disable time from low level | $R_L = 110\Omega$, | See Figure 6-6 | | 30 | 45 | ns |

5.4.3 Symbol Equivalents

| DATA-SHEET PARAMETER | TIA/EIA-422-B | TIA/EIA-485-A |
|----------------------|---------------------------|--|
| $ V_{OD1} $ | V_O | V_O |
| $ V_{OD2} $ | $V_t (R_L = 100\Omega)$ | $V_t (R_L = 54\Omega)$ |
| $ V_{OD3} $ | | V_t (Test Termination Measurement 2) |
| $\Delta V_{OD} $ | $ V_t - \bar{V}_t $ | $ V_t - \bar{V}_t $ |
| V_{OC} | $ V_{OS} $ | $ V_{OS} $ |
| $\Delta V_{OC} $ | $ V_{OS} - \bar{V}_{OS} $ | $ V_{OS} - \bar{V}_{OS} $ |
| I_{OS} | $ I_{sa} , I_{sb} $ | |
| I_O | $ I_{xa} , I_{xb} $ | I_{ia}, I_{ib} |

5.5 Receiver Sections

5.5.1 Electrical Characteristics

over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

| PARAMETER | | | TEST CONDITIONS | | MIN | TYP ⁽¹⁾ | MAX | UNIT |
|-----------|--|----------|------------------------|----------------------|---------------------|--------------------|----------|------------|
| V_{IT+} | Positive-going input threshold voltage | | $V_O = 2.7V,$ | $I_O = -0.4mA$ | | | 0.2 | V |
| V_{IT-} | Negative-going input threshold voltage | | $V_O = 0.5V,$ | $I_O = 16mA$ | -0.2 ⁽²⁾ | | | V |
| V_{hys} | Input hysteresis voltage ($V_{IT+} - V_{IT-}$) | | | | | 50 | | mV |
| V_{IK} | Enable clamp voltage | SN751177 | $I_I = -18mA$ | | | | -1.5 | V |
| V_{OH} | High-level output voltage | | $V_{ID} = 200mV,$ | $I_{OH} = -400\mu A$ | 2.7 | | | V |
| V_{OL} | Low-level output voltage | | $V_{ID} = -200mV$ | $I_{OL} = 8mA$ | | | 0.45 | V |
| | | | | $I_{OL} = 16mA$ | | | 0.5 | |
| I_{OZ} | High-impedance-state output current | SN751177 | $V_O = 0.4V$ to $2.4V$ | | | | ± 20 | μA |
| I_I | Line input current (see Note 7) | | Other input at 0V | $V_I = 12V$ | | | 1 | mA |
| | | | | $V_I = -7V$ | | | -0.8 | |
| I_{IH} | High-level enable input current | SN751177 | $V_{IH} = 2.7V$ | | | | 20 | μA |
| I_{IL} | Low-level enable input current | SN751177 | $V_{IL} = 0.4V$ | | | | -100 | μA |
| I_{OS} | Short-circuit output current (see Note 6) | | | | -15 | | -85 | μA |
| I_{CC} | Supply current | | No load, | outputs enabled | | 80 | 110 | mA |
| r_i | Input resistance | | | | 12 | | | k Ω |

- (1) All typical values are at $V_{CC} = 5V$ and $T_A = 25^\circ C$.
- (2) The algebraic convention, where the less positive (more negative) limit is designated as minimum, is used in this data sheet for common-mode output and threshold voltage levels only.
- (3) Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.
- (4) Refer to ANSI Standards TIA/EIA-422-B, TIA/EIA-423-A, and TIA/EIA-485-A for exact conditions.

5.5.2 Switching Characteristics

at $V_{CC} = 5V, C_L = 15pF, T_A = 25^\circ C$

| PARAMETER | | | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|-----------|---|----------|-----------------------------|----------------|-----|-----|-----|------|
| t_{PLH} | Propagation delay time, low- to high-level output | | $V_{ID} = -1.5V$ to $1.5V,$ | See Figure 6-7 | | 20 | 35 | ns |
| t_{PHL} | Propagation delay time, high- to low-level output | | | | | 22 | 35 | ns |
| t_{PZH} | Output enable time to high level | SN751177 | See Figure 6-8 | | | 17 | 25 | ns |
| t_{PZL} | Output enable time to low level | | | | | 20 | 27 | ns |
| t_{PHZ} | Output disable time from high level | | | | | 25 | 40 | ns |
| t_{PLZ} | Output disable time from low level | | | | | 30 | 40 | ns |

6 Parameter Measurement Information

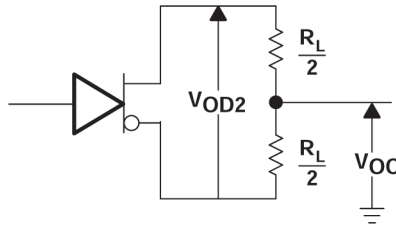


Figure 6-1. Driver Test Circuit, v_{OD} And v_{OC}

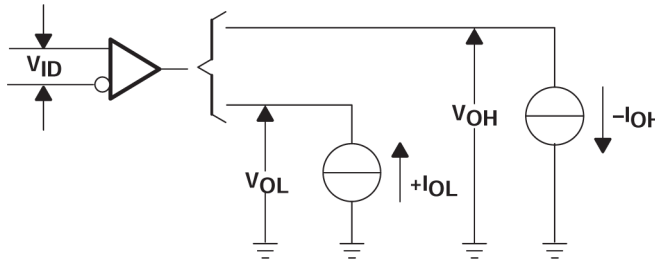
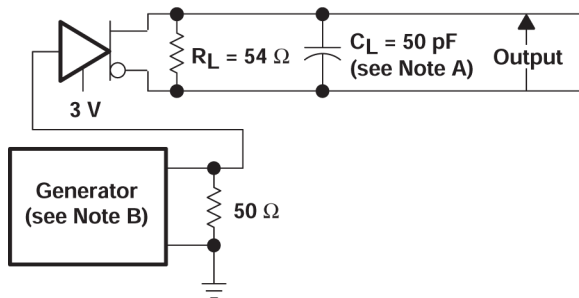
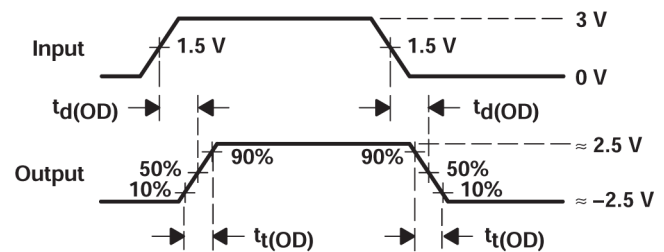


Figure 6-2. Receiver Test Circuit, v_{OH} And v_{OL}



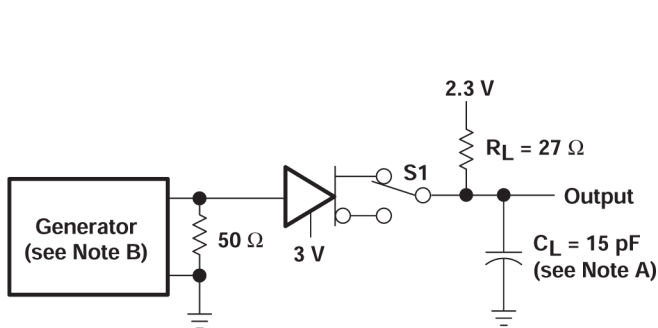
TEST CIRCUIT



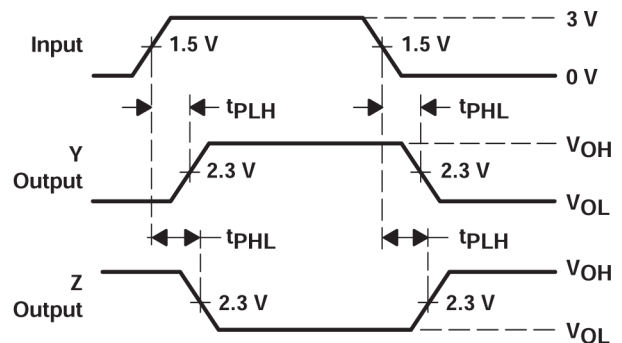
VOLTAGE WAVEFORMS

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: $PRR \leq 1\text{MHz}$, 50% duty cycle, $Z_O = 50\Omega$, $t_r \leq 6\text{ns}$, $t_f \leq 6\text{ns}$.

Figure 6-3. Driver Differential Output-Delay and Transition-Time Test Circuit and Voltage Waveforms



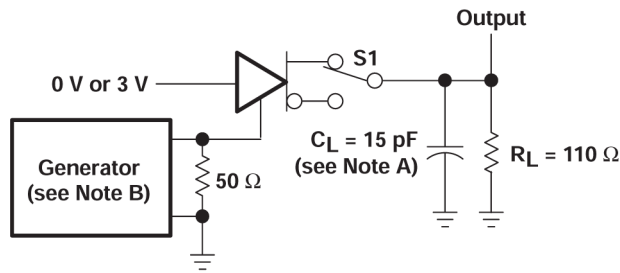
TEST CIRCUIT



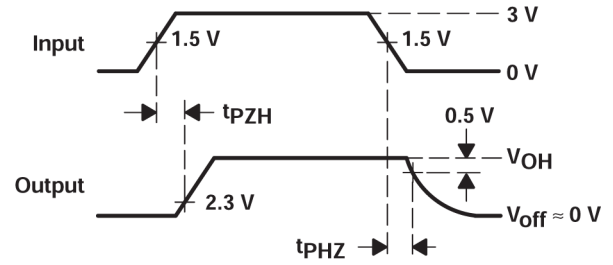
VOLTAGE WAVEFORMS

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: $PRR \leq 1\text{MHz}$, 50% duty cycle, $Z_O = 50\Omega$, $t_r \leq 6\text{ns}$, $t_f \leq 6\text{ns}$.

Figure 6-4. Driver Propagation-Time Test Circuit and Voltage Waveforms



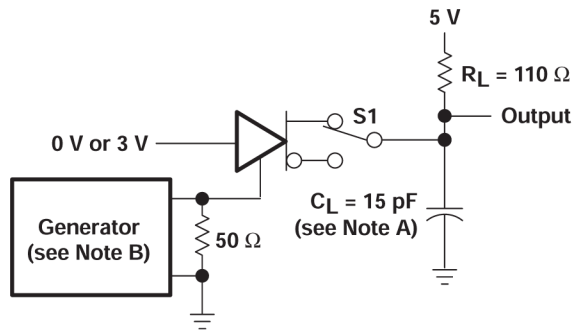
TEST CIRCUIT



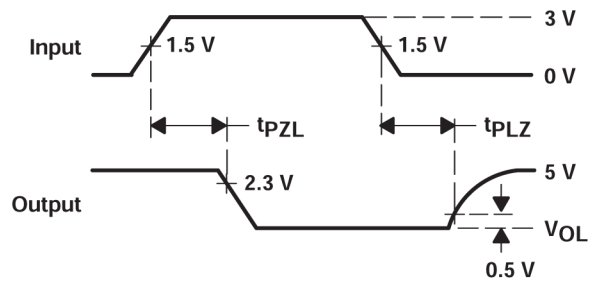
VOLTAGE WAVEFORMS

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: $PRR \leq 1\text{MHz}$, 50% duty cycle, $Z_O = 50\Omega$, $t_r \leq 6\text{ns}$, $t_f \leq 6\text{ns}$.

Figure 6-5. Driver Enable- and Disable-Time Test Circuit and Voltage Waveforms



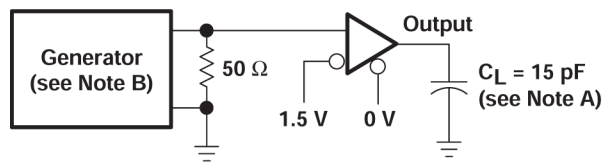
TEST CIRCUIT



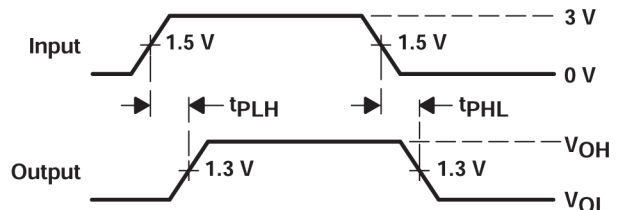
VOLTAGE WAVEFORMS

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: $PRR \leq 1\text{MHz}$, 50% duty cycle, $Z_O = 50\Omega$, $t_r \leq 6\text{ns}$, $t_f \leq 6\text{ns}$.

Figure 6-6. Driver Enable- and Disable-Time Test Circuit and Voltage Waveforms



TEST CIRCUIT



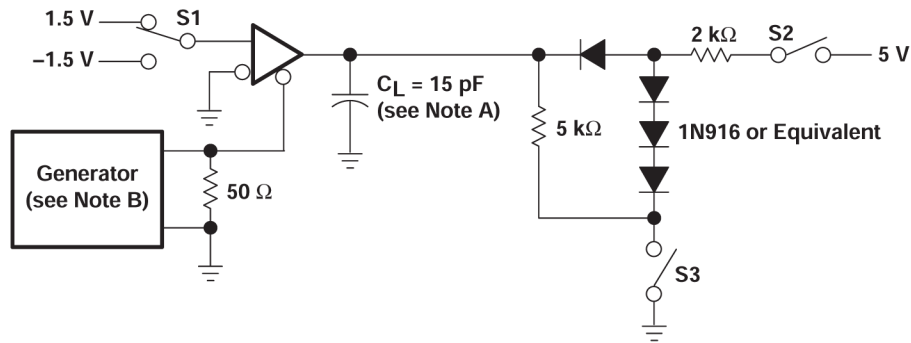
VOLTAGE WAVEFORMS

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: $PRR \leq 1\text{MHz}$, 50% duty cycle, $Z_O = 50\Omega$, $t_r \leq 6\text{ns}$, $t_f \leq 6\text{ns}$.

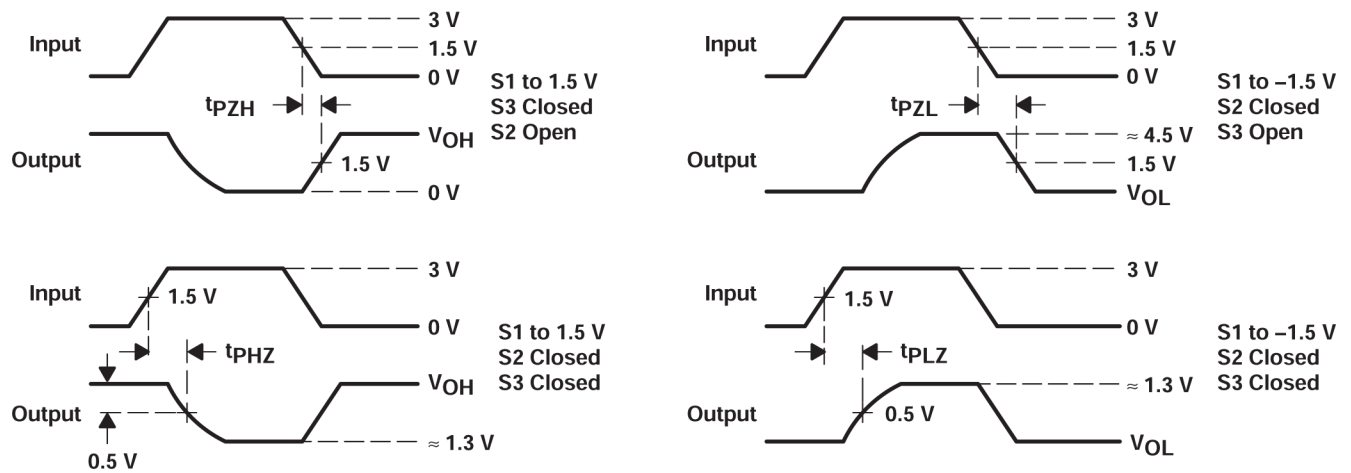
Figure 6-7. Receiver Propagation-Time Test Circuit and Voltage Waveforms

SN751177, SN751178

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TEST CIRCUIT



VOLTAGE WAVEFORMS

- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: $PRR \leq 1 \text{ MHz}$, 50% duty cycle, $Z_O = 50 \Omega$, $t_r \leq 6 \text{ ns}$, $t_f \leq 6 \text{ ns}$.

Figure 6-8. Receiver Output Enable- and Disable-Time Test Circuit and Voltage Waveforms

7 Detailed Description

7.1 Device Functional Modes

Table 7-1. SN751177, SN751178 Functional Table (Each Driver)

| INPUT D ⁽¹⁾ | ENABLE DE | OUTPUTS | |
|------------------------|-----------|---------|---|
| | | Y | Z |
| H | H | H | L |
| L | H | L | H |
| X | L | Z | Z |

(1) H = high level, L = low level, X = irrelevant, Z = high impedance (off)

Table 7-2. SN751177 Functional Table (Each Receiver)

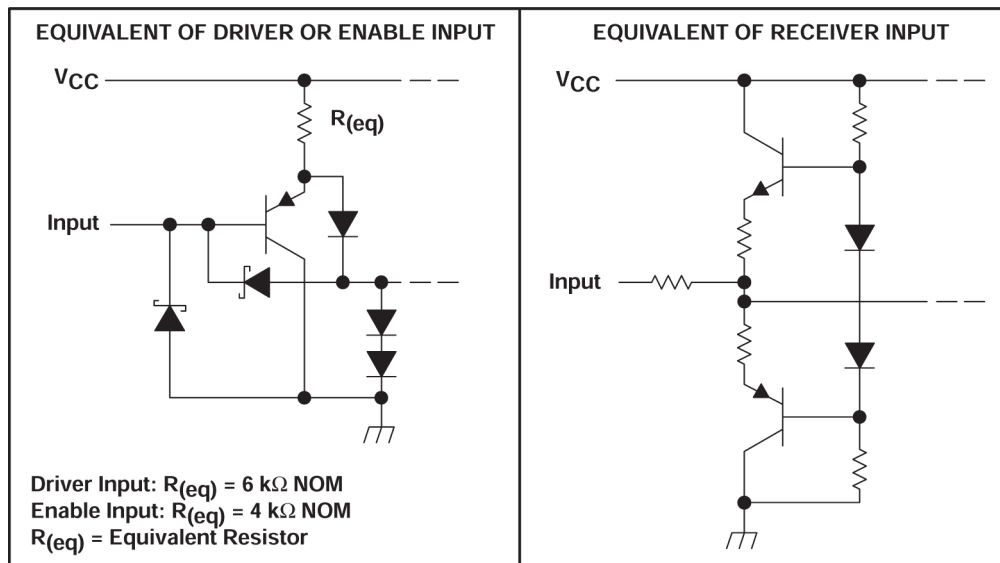
| DIFFERENTIAL INPUTS A – B | ENABLE RE | OUTPUT R ⁽¹⁾ |
|---------------------------|-----------|-------------------------|
| $V_{ID} \geq 0.2V$ | L | H |
| $-0.2V < V_{ID} < 0.2V$ | L | ? |
| $V_{ID} \leq -0.2V$ | L | L |
| X | H | Z |
| Open | L | H |

(1) H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = high impedance (off)

Table 7-3. SN751178 Functional Table (Each Receiver)

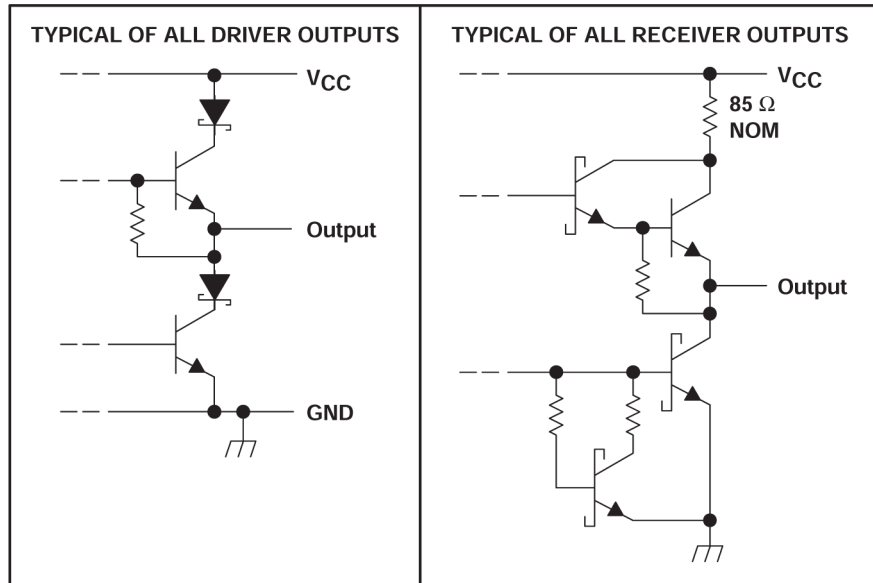
| DIFFERENTIAL INPUTS A – B | OUTPUT R ⁽¹⁾ |
|---------------------------|-------------------------|
| $V_{ID} \geq 0.2V$ | H |
| $-0.2V < V_{ID} < 0.2V$ | ? |
| $V_{ID} \leq -0.2V$ | L |

(1) H = high level, L = low level, ? = indeterminate



A. All resistor values are nominal.

Figure 7-1. Schematics of Inputs



A. All resistor values are nominal.

Figure 7-2. Schematics of Outputs

8 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

8.1 Documentation Support

8.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](https://www.ti.com). Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

8.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

8.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.
All trademarks are the property of their respective owners.

8.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

8.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision D (May 1999) to Revision E (February 2024) | Page |
|---|-------------|
| • Changed the numbering format for tables, figures, and cross-references throughout the document..... | 1 |

10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| SN751177N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -20 to 85 | SN751177N | Samples |
| SN751177NSR | ACTIVE | SO | NS | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -20 to 85 | SN751177 | Samples |
| SN751177NSRE4 | ACTIVE | SO | NS | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -20 to 85 | SN751177 | Samples |
| SN751178N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -20 to 85 | SN751178N | Samples |
| SN751178NSR | ACTIVE | SO | NS | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -20 to 85 | SN751178 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN751177NSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN751177NSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN751178NSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN751178NSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.45 | 10.55 | 2.5 | 12.0 | 16.2 | Q1 |

TAPE AND REEL BOX DIMENSIONS

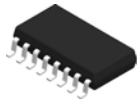

*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN751177NSR | SO | NS | 16 | 2000 | 353.0 | 353.0 | 32.0 |
| SN751177NSR | SO | NS | 16 | 2000 | 356.0 | 356.0 | 35.0 |
| SN751178NSR | SO | NS | 16 | 2000 | 353.0 | 353.0 | 32.0 |
| SN751178NSR | SO | NS | 16 | 2000 | 356.0 | 356.0 | 35.0 |

TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-----------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN751177N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN751178N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |

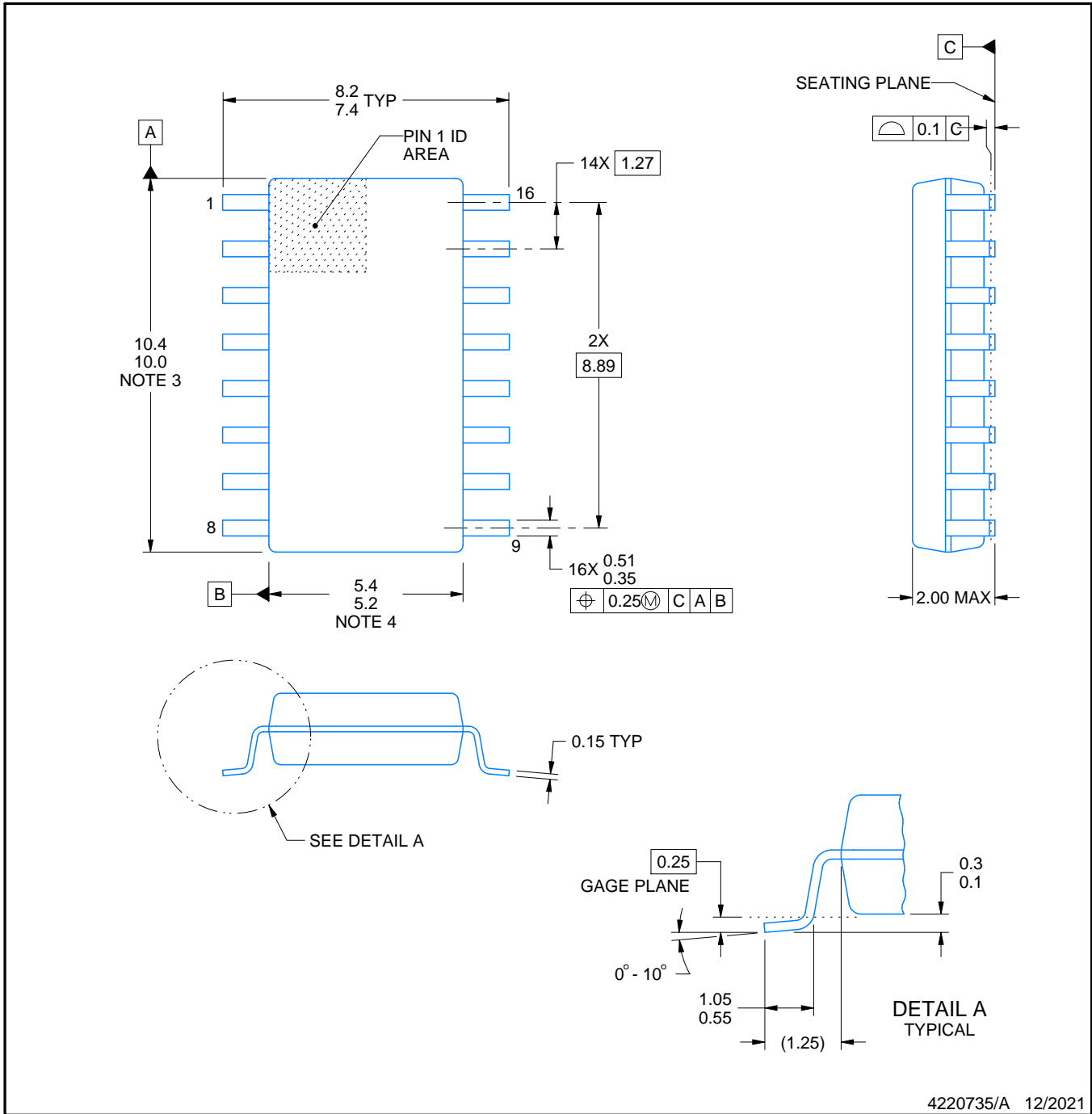


PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

SOP



NOTES:

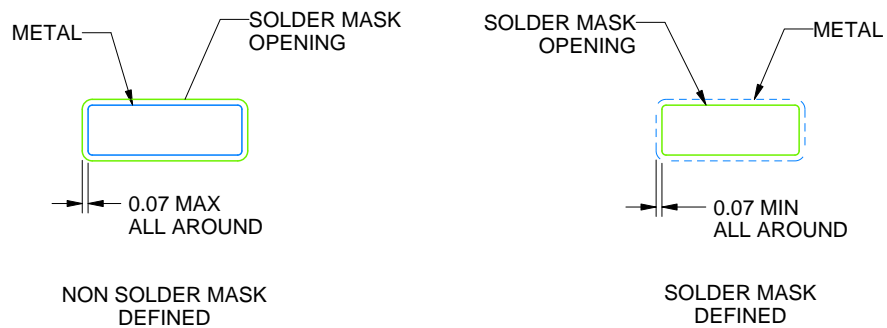
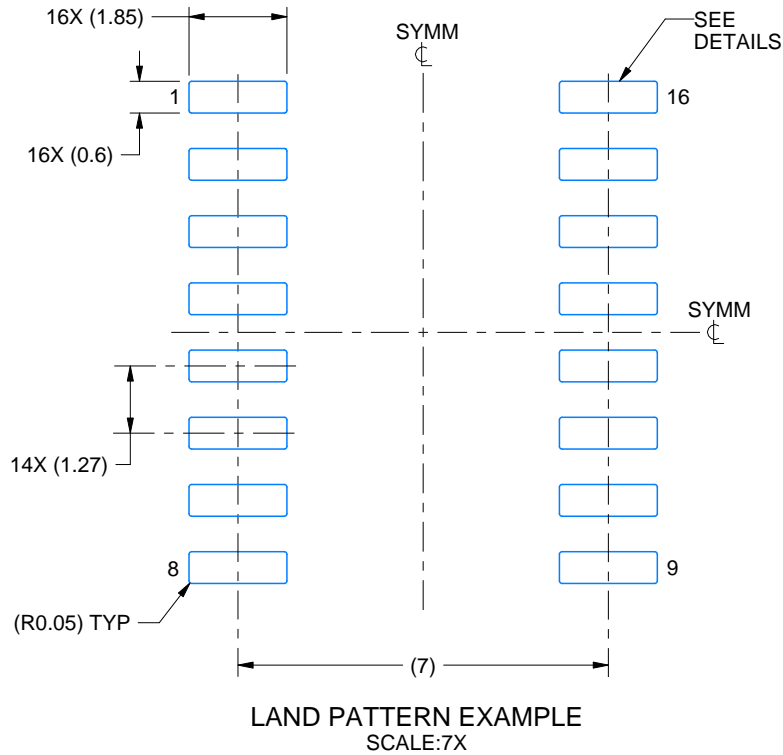
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

EXAMPLE BOARD LAYOUT

NS0016A

SOP - 2.00 mm max height

SOP



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NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

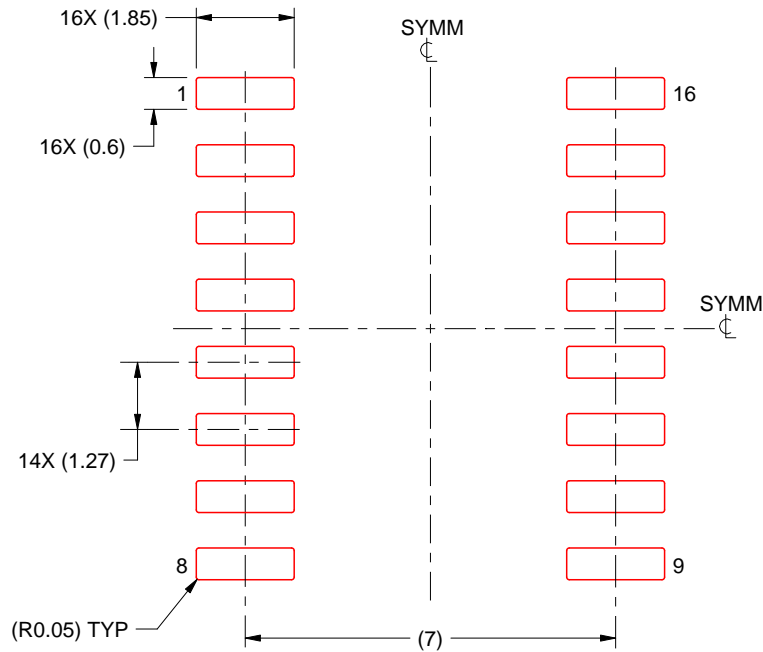
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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